

SBG1030CT - SBG1045CT

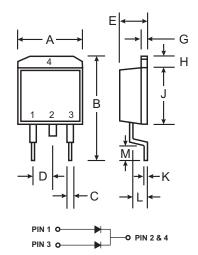
10A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- Surge Overload Rating to 125A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish/RoHS Compliant (Note 3)

Mechanical Data

- Case: D²PAK
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Bright Tin. Solderable per MIL-STD-202, Method 208
- Ordering Information, Note 5, on Page 2
- Polarity: See Diagram
- Marking: Type Number
- Mounting Position: Any
- Weight: 1.7 grams (approximate)



D ² PAK						
Dim	Min	Max				
Α	9.65	10.69				
В	14.60	15.88				
С	0.51	1.14				
D	2.29	2.79				
E	4.37	4.83				
G	1.14	1.40				
Н	1.14	1.40				
J	8.25	9.25				
K	0.30	0.64				
L	2.03	2.92				
М	2.29	2.79				
All Dimensions in mm						

Maximum Ratings and Electrical Characteristics @ TA = 25°C unless otherwise specified

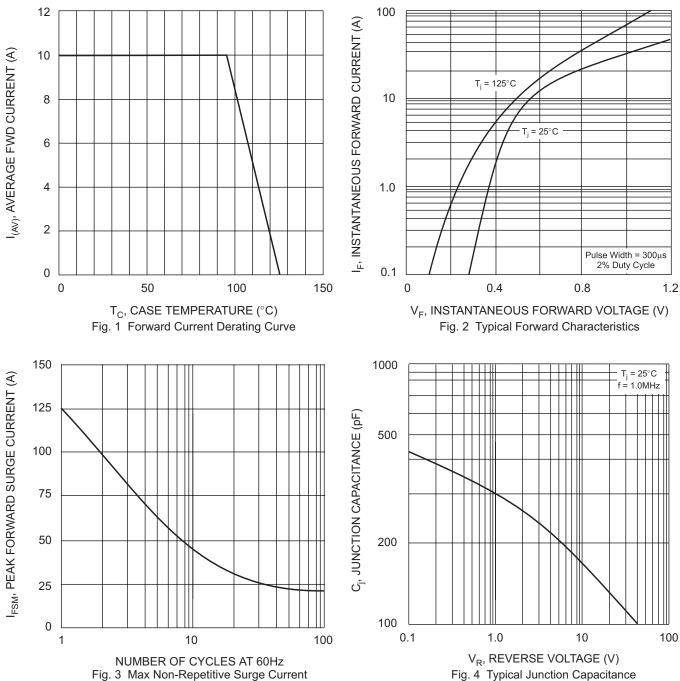
Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	SBG 1030CT	SBG 1035CT	SBG 1040CT	SBG 1045CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	30	35	40	45	V
RMS Reverse Voltage		V _{R(RMS)}	21	25	28	32	V
Average Rectified Output Current @	T _C = 95°C	Io	10			Α	
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)		I _{FSM}	125			А	
Forward Voltage, per Element @	$I_F = 5.0A$	V _{FM}		0.	55		V
$ \begin{array}{lll} \mbox{Peak Reverse Current} & \mbox{@ } T_j = 25^{\circ}\mbox{C} \\ \mbox{at Rated DC Blocking Voltage} & \mbox{@ } T_j = 125^{\circ}\mbox{C} \\ \end{array} $		I _{RM}	1.0 50		mA		
Typical Junction Capacitance (Note 2)		Cj	275			pF	
Typical Thermal Resistance Junction to Case (Note 1)		R ₀ JC	3.0			K/W	
Operating and Storage Temperature Range		T _{j,} T _{STG}	-65 to +125			°C	

Notes: 1. Thermal resistance: junction to case mounted on heat sink.

- 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 3. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.





Ordering Information (Note 4)

Device	Packaging	Shipping
SBG1030CT-T-F	D ² PAK	800/Tape & Reel, 13-inch
SBG1035CT-T-F	D ² PAK	800/Tape & Reel, 13-inch
SBG1040CT-T-F	D ² PAK	800/Tape & Reel, 13-inch
SBG1045CT-T-F	D ² PAK	800/Tape & Reel, 13-inch

Notes: 4. For packaging details, visit our website at http://www.diodes.com/datasheets/ap02007.pdf.



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